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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | ARM® Cortex®-M0 |
| Core Size | 32-Bit Single-Core |
| Speed | 50MHz |
| Connectivity | I ² C, SPI, UART/USART |
| Peripherals | Brown-out Detect/Reset, POR, WDT |
| Number of I/O | 28 |
| Program Memory Size | 24KB (24K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 8K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.8V ~ 3.6V |
| Data Converters | A/D 8x10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 105°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 32-VQFN Exposed Pad |
| Supplier Device Package | 32-HVQFN (7x7) |
| Purchase URL | https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1113jhn33-303e |

- Digital peripherals:
 - ◆ Up to 42 General Purpose I/O (GPIO) pins with configurable pull-up/pull-down resistors. In addition, a configurable open-drain mode is supported on the LPC1100L and LPC1100XL series.
 - ◆ GPIO pins can be used as edge and level sensitive interrupt sources.
 - ◆ High-current output driver (20 mA) on one pin.
 - ◆ High-current sink drivers (20 mA) on two I²C-bus pins in Fast-mode Plus (not on LPC1112FDH20/102).
 - ◆ Four general purpose counter/timers with up to eight capture inputs and up to 13 match outputs.
 - ◆ Programmable WatchDog Timer (WDT) the LPC1100 series only.
 - ◆ Programmable windowed WDT on the LPC1100L and LPC1100XL series only.
- Analog peripherals:
 - ◆ 10-bit ADC with input multiplexing among 5, 6, or 8 pins depending on package size.
- Serial interfaces:
 - ◆ UART with fractional baud rate generation, internal FIFO, and RS-485 support.
 - ◆ Two SPI controllers with SSP features and with FIFO and multi-protocol capabilities (second SPI on LPC1100 and LPC1100L series LQFP48 package only).
 - ◆ I²C-bus interface supporting full I²C-bus specification and Fast-mode Plus with a data rate of 1 Mbit/s with multiple address recognition and monitor mode (not on LPC1112FDH20/102).
- Clock generation:
 - ◆ 12 MHz internal RC oscillator trimmed to 1 % accuracy that can optionally be used as a system clock.
 - ◆ Crystal oscillator with an operating range of 1 MHz to 25 MHz.
 - ◆ Programmable watchdog oscillator with a frequency range of 9.4 kHz to 2.3 MHz.
 - ◆ PLL allows CPU operation up to the maximum CPU rate without the need for a high-frequency crystal. May be run from the system oscillator or the internal RC oscillator.
 - ◆ Clock output function with divider that can reflect the system oscillator clock, IRC clock, CPU clock, and the Watchdog clock.
- Power control:
 - ◆ Integrated PMU (Power Management Unit) to minimize power consumption during Sleep, Deep-sleep, and Deep power-down modes.
 - ◆ Power profiles residing in boot ROM allowing to optimize performance and minimize power consumption for any given application through one simple function call. (LPC1100L and LPC1100XL series only.)
 - ◆ Three reduced power modes: Sleep, Deep-sleep, and Deep power-down.
 - ◆ Processor wake-up from Deep-sleep mode via a dedicated start logic using up to 13 of the functional pins.
 - ◆ Power-On Reset (POR).
 - ◆ Brownout detect with up to four separate thresholds for interrupt and forced reset.
- Unique device serial number for identification.
- Single power supply (1.8 V to 3.6 V).
- Available as LQFP48 package, HVQFN33 package, and TFBGA48 package.

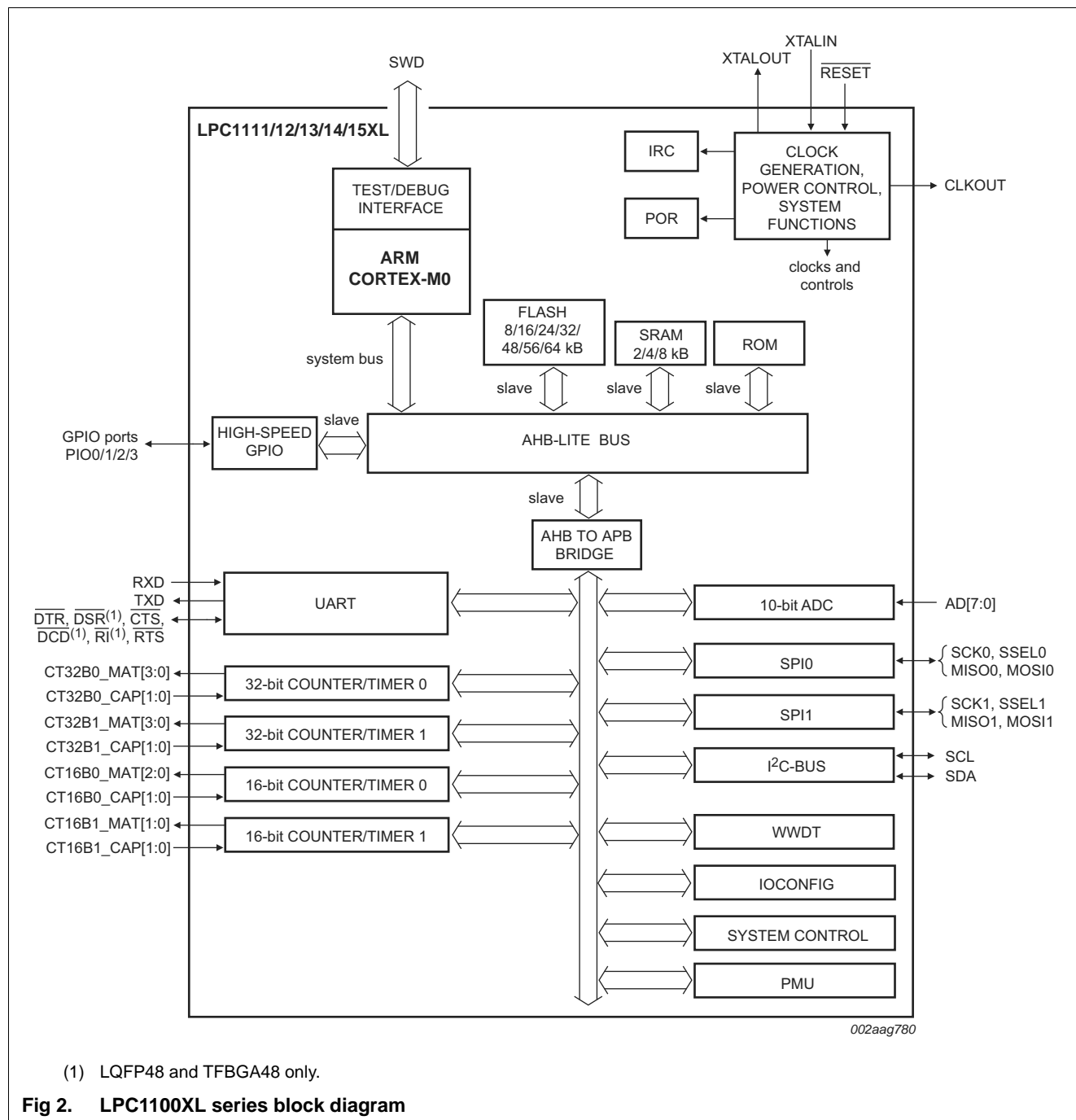


Table 8. LPC1100 and LPC1100L series: LPC1113/14 pin description table (LQFP48 package) ...continued

| Symbol | Pin | Start logic input | Type | Reset state [1] | Description |
|---------------------------------|-------------------|-------------------|------|-----------------|--|
| PIO3_0 to PIO3_5 | | | I/O | | Port 3 — Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_6 to PIO3_11 are not available. |
| PIO3_0/ $\overline{\text{DTR}}$ | 36 ^[3] | no | I/O | I; PU | PIO3_0 — General purpose digital input/output pin. |
| | | | O | - | DTR — Data Terminal Ready output for UART. |
| PIO3_1/ $\overline{\text{DSR}}$ | 37 ^[3] | no | I/O | I; PU | PIO3_1 — General purpose digital input/output pin. |
| | | | I | - | DSR — Data Set Ready input for UART. |
| PIO3_2/ $\overline{\text{DCD}}$ | 43 ^[3] | no | I/O | I; PU | PIO3_2 — General purpose digital input/output pin. |
| | | | I | - | DCD — Data Carrier Detect input for UART. |
| PIO3_3/ $\overline{\text{RI}}$ | 48 ^[3] | no | I/O | I; PU | PIO3_3 — General purpose digital input/output pin. |
| | | | I | - | RI — Ring Indicator input for UART. |
| PIO3_4 | 18 ^[3] | no | I/O | I; PU | PIO3_4 — General purpose digital input/output pin. |
| PIO3_5 | 21 ^[3] | no | I/O | I; PU | PIO3_5 — General purpose digital input/output pin. |
| V _{DD} | 8; 44 | - | I | - | 3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage. |
| XTALIN | 6 ^[6] | - | I | - | Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V. |
| XTALOUT | 7 ^[6] | - | O | - | Output from the oscillator amplifier. |
| V _{SS} | 5; 41 | - | I | - | Ground. |

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to 2.6 V for LPC111x/101/201/301, pins pulled up to full V_{DD} level on LPC111x/002/102/202/302 (V_{DD} = 3.3 V)); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. $\overline{\text{RESET}}$ functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I²C-bus pads compliant with the I²C-bus specification for I²C standard mode and I²C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I²C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see [Figure 51](#)).
- [6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 9. LPC1100 and LPC1100L series: LPC1111/12/13/14 pin description table (HVQFN33 package) ...continued

| Symbol | Pin | Start logic input | Type | Reset state [1] | Description |
|-----------------------------|-------------------|-------------------|------|-----------------|---|
| PIO1_7/TXD/ CT32B0_MAT1 | 32 ^[3] | no | I/O | I;PU | PIO1_7 — General purpose digital input/output pin. |
| | | | O | - | TXD — Transmitter output for UART. |
| | | | O | - | CT32B0_MAT1 — Match output 1 for 32-bit timer 0. |
| PIO1_8/ CT16B1_CAP0 | 7 ^[3] | no | I/O | I;PU | PIO1_8 — General purpose digital input/output pin. |
| | | | I | - | CT16B1_CAP0 — Capture input 0 for 16-bit timer 1. |
| PIO1_9/ CT16B1_MAT0 | 12 ^[3] | no | I/O | I;PU | PIO1_9 — General purpose digital input/output pin. |
| | | | O | - | CT16B1_MAT0 — Match output 0 for 16-bit timer 1. |
| PIO1_10/AD6/ CT16B1_MAT1 | 20 ^[5] | no | I/O | I;PU | PIO1_10 — General purpose digital input/output pin. |
| | | | I | - | AD6 — A/D converter, input 6. |
| | | | O | - | CT16B1_MAT1 — Match output 1 for 16-bit timer 1. |
| PIO1_11/AD7 | 27 ^[5] | no | I/O | I;PU | PIO1_11 — General purpose digital input/output pin. |
| | | | I | - | AD7 — A/D converter, input 7. |
| PIO2_0 | | | | | Port 2 — Port 2 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 2 pins depends on the function selected through the IOCONFIG register block. Pins PIO2_1 to PIO2_11 are not available. |
| PIO2_0/DTR | 1 ^[3] | no | I/O | I;PU | PIO2_0 — General purpose digital input/output pin. |
| | | | O | - | DTR — Data Terminal Ready output for UART. |
| PIO3_0 to PIO3_5 | | | | | Port 3 — Port 3 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 3 pins depends on the function selected through the IOCONFIG register block. Pins PIO3_0, PIO3_1, PIO3_3 and PIO3_6 to PIO3_11 are not available. |
| PIO3_2 | 28 ^[3] | no | I/O | I;PU | PIO3_2 — General purpose digital input/output pin. |
| PIO3_4 | 13 ^[3] | no | I/O | I;PU | PIO3_4 — General purpose digital input/output pin. |
| PIO3_5 | 14 ^[3] | no | I/O | I;PU | PIO3_5 — General purpose digital input/output pin. |
| V _{DD} | 6; 29 | - | I | - | 3.3 V supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage. |
| XTALIN | 4 ^[6] | - | I | - | Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V. |
| XTALOUT | 5 ^[6] | - | O | - | Output from the oscillator amplifier. |
| V _{SS} | 33 | - | - | - | Thermal pad. Connect to ground. |

- [1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled (pins pulled up to 2.6 V for LPC111x/101/201/301, pins pulled up to full V_{DD} level on LPC111x/002/102/202/302 (V_{DD} = 3.3 V)); IA = inactive, no pull-up/down enabled.
- [2] 5 V tolerant pad. **RESET** functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See [Figure 52](#) for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see [Figure 51](#)).
- [4] I²C-bus pads compliant with the I²C-bus specification for I²C standard mode and I²C Fast-mode Plus. The pin requires an external pull-up to provide output functionality. When power is switched off, this pin is floating and does not disturb the I2C lines. Open-drain configuration applies to all functions on this pin.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled, and the pin is not 5 V tolerant (see [Figure 51](#)).

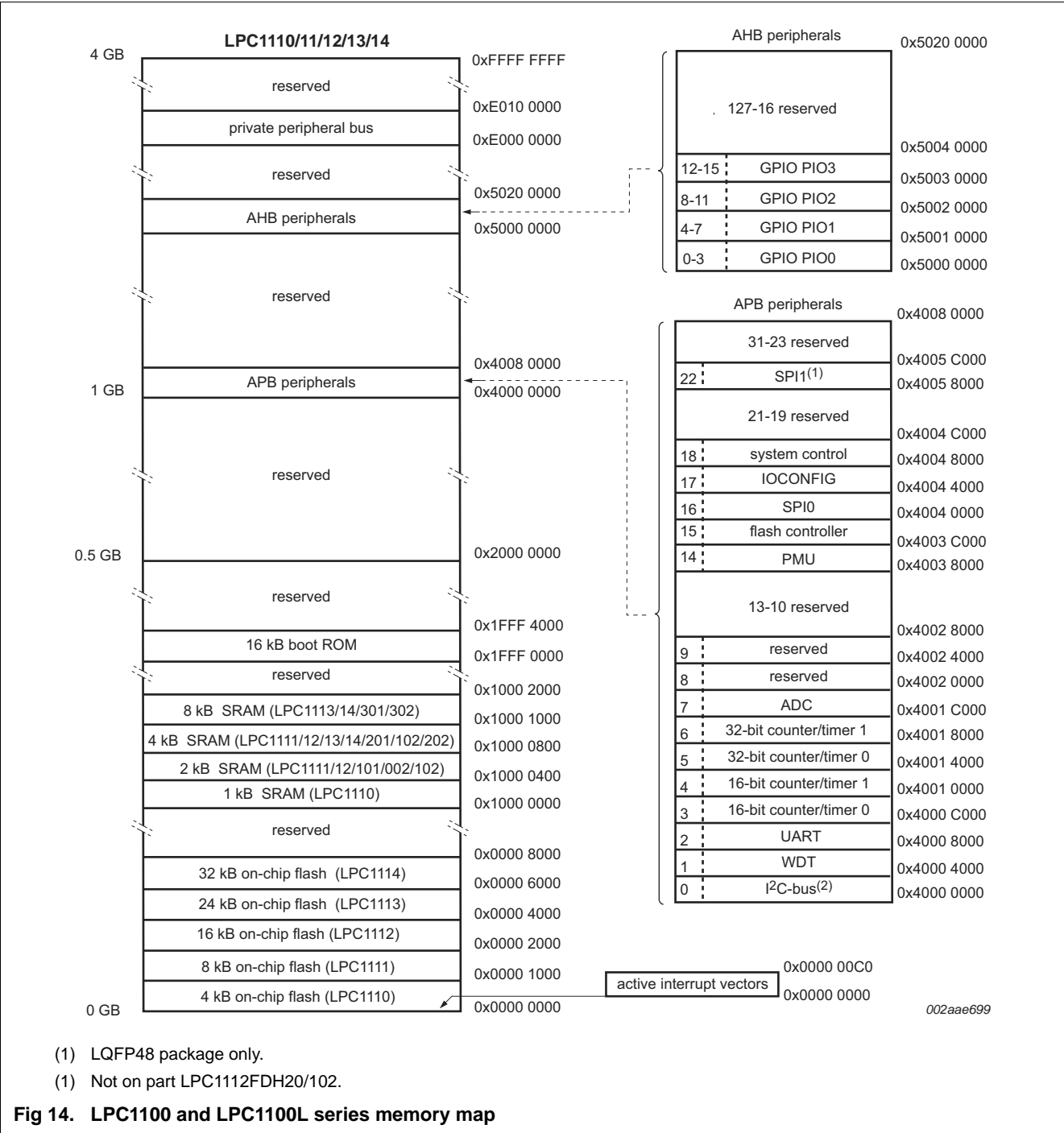
[6] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). XTALOUT should be left floating.

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package)

| Symbol | LQFP48 | TFBGA48 | Start logic input | Type | Reset state [1] | Description |
|---------------------------|--------|---------|-------------------|------|-----------------|--|
| PIO0_0 to PIO0_11 | | | | I/O | | Port 0 — Port 0 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 0 pins depends on the function selected through the IOCONFIG register block. |
| RESET/PIO0_0 | 3[2] | C1[2] | yes | I | I; PU | RESET — External reset input with 20 ns glitch filter. A LOW-going pulse as short as 50 ns on this pin resets the device, causing I/O ports and peripherals to take on their default states, and processor execution to begin at address 0. In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed and Deep power-down mode is not used. |
| | | | | I/O | - | PIO0_0 — General purpose digital input/output pin with 10 ns glitch filter. |
| PIO0_1/CLKOUT/CT32B0_MAT2 | 4[3] | C2[3] | yes | I/O | I; PU | PIO0_1 — General purpose digital input/output pin. A LOW level on this pin during reset starts the ISP command handler. |
| | | | | O | - | CLKOUT — Clockout pin. |
| | | | | O | - | CT32B0_MAT2 — Match output 2 for 32-bit timer 0. |
| PIO0_2/SSEL0/CT16B0_CAP0 | 10[3] | F1[3] | yes | I/O | I; PU | PIO0_2 — General purpose digital input/output pin. |
| | | | | I/O | - | SSEL0 — Slave Select for SPI0. |
| | | | | I | - | CT16B0_CAP0 — Capture input 0 for 16-bit timer 0. |
| PIO0_3 | 14[3] | H2[3] | yes | I/O | I; PU | PIO0_3 — General purpose digital input/output pin. |
| PIO0_4/SCL | 15[4] | G3[4] | yes | I/O | I; IA | PIO0_4 — General purpose digital input/output pin (open-drain). |
| | | | | I/O | - | SCL — I ² C-bus, open-drain clock input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register. |
| PIO0_5/SDA | 16[4] | H3[4] | yes | I/O | I; IA | PIO0_5 — General purpose digital input/output pin (open-drain). |
| | | | | I/O | - | SDA — I ² C-bus, open-drain data input/output. High-current sink only if I ² C Fast-mode Plus is selected in the I/O configuration register. |
| PIO0_6/SCK0 | 22[3] | H6[3] | yes | I/O | I; PU | PIO0_6 — General purpose digital input/output pin. |
| | | | | I/O | - | SCK0 — Serial clock for SPI0. |
| PIO0_7/CTS | 23[3] | G7[3] | yes | I/O | I; PU | PIO0_7 — General purpose digital input/output pin (high-current output driver). |
| | | | | I | - | CTS — Clear To Send input for UART. |

Table 10. LPC1100XL series: LPC1113/14/15 pin description table (LQFP48 and TFBGA48 package) ...continued

| Symbol | LQFP48 | TFBGA48 | Start logic input | Type | Reset state [1] | Description |
|--------------------------------|-------------------|-------------------|-------------------|------|-----------------|--|
| PIO0_8/MISO0/CT16B0_MAT0 | 27 ^[3] | F8 ^[3] | yes | I/O | I; PU | PIO0_8 — General purpose digital input/output pin. |
| | | | | I/O | - | MISO0 — Master In Slave Out for SPI0. |
| | | | | O | - | CT16B0_MAT0 — Match output 0 for 16-bit timer 0. |
| PIO0_9/MOSI0/CT16B0_MAT1 | 28 ^[3] | F7 ^[3] | yes | I/O | I; PU | PIO0_9 — General purpose digital input/output pin. |
| | | | | I/O | - | MOSI0 — Master Out Slave In for SPI0. |
| | | | | O | - | CT16B0_MAT1 — Match output 1 for 16-bit timer 0. |
| SWCLK/PIO0_10/SCK0/CT16B0_MAT2 | 29 ^[3] | E7 ^[3] | yes | I | I; PU | SWCLK — Serial wire clock. |
| | | | | I/O | - | PIO0_10 — General purpose digital input/output pin. |
| | | | | I/O | - | SCK0 — Serial clock for SPI0. |
| | | | | O | - | CT16B0_MAT2 — Match output 2 for 16-bit timer 0. |
| R/PIO0_11/AD0/CT32B0_MAT3 | 32 ^[5] | D8 ^[5] | yes | I | I; PU | R — Reserved. Configure for an alternate function in the IOCONFIG block. |
| | | | | I/O | - | PIO0_11 — General purpose digital input/output pin. |
| | | | | I | - | AD0 — A/D converter, input 0. |
| | | | | O | - | CT32B0_MAT3 — Match output 3 for 32-bit timer 0. |
| PIO1_0 to PIO1_11 | | | | I/O | | Port 1 — Port 1 is a 12-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block. |
| R/PIO1_0/AD1/CT32B1_CAP0 | 33 ^[5] | C7 ^[5] | yes | I | I; PU | R — Reserved. Configure for an alternate function in the IOCONFIG block. |
| | | | | I/O | - | PIO1_0 — General purpose digital input/output pin. |
| | | | | I | - | AD1 — A/D converter, input 1. |
| | | | | I | - | CT32B1_CAP0 — Capture input 0 for 32-bit timer 1. |
| R/PIO1_1/AD2/CT32B1_MAT0 | 34 ^[5] | C8 ^[5] | no | O | I; PU | R — Reserved. Configure for an alternate function in the IOCONFIG block. |
| | | | | I/O | - | PIO1_1 — General purpose digital input/output pin. |
| | | | | I | - | AD2 — A/D converter, input 2. |
| | | | | O | - | CT32B1_MAT0 — Match output 0 for 32-bit timer 1. |
| R/PIO1_2/AD3/CT32B1_MAT1 | 35 ^[5] | B7 ^[5] | no | I | I; PU | R — Reserved. Configure for an alternate function in the IOCONFIG block. |
| | | | | I/O | - | PIO1_2 — General purpose digital input/output pin. |
| | | | | I | - | AD3 — A/D converter, input 3. |
| | | | | O | - | CT32B1_MAT1 — Match output 1 for 32-bit timer 1. |
| SWDIO/PIO1_3/AD4/CT32B1_MAT2 | 39 ^[5] | B6 ^[5] | no | I/O | I; PU | SWDIO — Serial wire debug input/output. |
| | | | | I/O | - | PIO1_3 — General purpose digital input/output pin. |
| | | | | I | - | AD4 — A/D converter, input 4. |
| | | | | O | - | CT32B1_MAT2 — Match output 2 for 32-bit timer 1. |



CAUTION

If level three Code Read Protection (CRP3) is selected, no future factory testing can be performed on the device.

In addition to the three CRP levels, sampling of pin PIO0_1 for valid user code can be disabled. For details see the *LPC111x user manual*.

7.17.5 APB interface

The APB peripherals are located on one APB bus.

7.17.6 AHBLite

The AHBLite connects the CPU bus of the ARM Cortex-M0 to the flash memory, the main static RAM, and the Boot ROM.

7.17.7 External interrupt inputs

All GPIO pins can be level or edge sensitive interrupt inputs. In addition, start logic inputs serve as external interrupts (see [Section 7.17.1](#)).

7.18 Emulation and debugging

Debug functions are integrated into the ARM Cortex-M0. Serial wire debug with four breakpoints and two watchpoints is supported.

Table 16. Static characteristics (LPC1100, LPC1100L series) ...continued

 $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|--------------------------------|---|--|-----------------------|--------------------|--------------------|------|
| Standard port pins, RESET | | | | | | |
| I _{IL} | LOW-level input current | V _I = 0 V; on-chip pull-up resistor disabled | - | 0.5 | 10 | nA |
| I _{IH} | HIGH-level input current | V _I = V _{DD} ; on-chip pull-down resistor disabled | - | 0.5 | 10 | nA |
| I _{OZ} | OFF-state output current | V _O = 0 V; V _O = V _{DD} ; on-chip pull-up/down resistors disabled | - | 0.5 | 10 | nA |
| V _I | input voltage | pin configured to provide a digital function ^{[12][13][14]} | 0 | - | 5.0 | V |
| V _O | output voltage | output active | 0 | - | V _{DD} | V |
| V _{IH} | HIGH-level input voltage | | 0.7V _{DD} | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.3V _{DD} | V |
| V _{hys} | hysteresis voltage | | - | 0.4 | - | V |
| V _{OH} | HIGH-level output voltage | 2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OH} = −4 mA | V _{DD} − 0.4 | - | - | V |
| | | 1.8 V ≤ V _{DD} < 2.5 V; I _{OH} = −3 mA | V _{DD} − 0.4 | - | - | V |
| V _{OL} | LOW-level output voltage | 2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OL} = 4 mA | - | - | 0.4 | V |
| | | 1.8 V ≤ V _{DD} < 2.5 V; I _{OL} = 3 mA | - | - | 0.4 | V |
| I _{OH} | HIGH-level output current | V _{OH} = V _{DD} − 0.4 V; 2.5 V ≤ V _{DD} ≤ 3.6 V | −4 | - | - | mA |
| | | 1.8 V ≤ V _{DD} < 2.5 V | −3 | - | - | mA |
| I _{OL} | LOW-level output current | V _{OL} = 0.4 V 2.5 V ≤ V _{DD} ≤ 3.6 V | 4 | - | - | mA |
| | | 1.8 V ≤ V _{DD} < 2.5 V | 3 | - | - | mA |
| I _{OHS} | HIGH-level short-circuit output current | V _{OH} = 0 V ^[15] | - | - | −45 | mA |
| I _{OLS} | LOW-level short-circuit output current | V _{OL} = V _{DD} ^[15] | - | - | 50 | mA |
| I _{pd} | pull-down current | V _I = 5 V | 10 | 50 | 150 | μA |
| I _{pu} | pull-up current | V _I = 0 V; 2.0 V ≤ V _{DD} ≤ 3.6 V | −15 | −50 | −85 | μA |
| | | 1.8 V ≤ V _{DD} < 2.0 V | −10 | −50 | −85 | μA |
| | | V _{DD} < V _I < 5 V | 0 | 0 | 0 | μA |
| High-drive output pin (PIO0_7) | | | | | | |
| I _{IL} | LOW-level input current | V _I = 0 V; on-chip pull-up resistor disabled | - | 0.5 | 10 | nA |
| I _{IH} | HIGH-level input current | V _I = V _{DD} ; on-chip pull-down resistor disabled | - | 0.5 | 10 | nA |

Table 16. Static characteristics (LPC1100, LPC1100L series) ...continued $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$, unless otherwise specified.

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|---|--|--|-----------------------|---------------------|--------------------|------|
| I _{OZ} | OFF-state output current | V _O = 0 V; V _O = V _{DD} ; on-chip pull-up/down resistors disabled | - | 0.5 | 10 | nA |
| V _I | input voltage | pin configured to provide a digital function ^{[12][13]} ^[14] | 0 | - | 5.0 | V |
| V _O | output voltage | output active | 0 | - | V _{DD} | V |
| V _{IH} | HIGH-level input voltage | | 0.7V _{DD} | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.3V _{DD} | V |
| V _{hys} | hysteresis voltage | | 0.4 | - | - | V |
| V _{OH} | HIGH-level output voltage | 2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OH} = −20 mA | V _{DD} − 0.4 | - | - | V |
| | | 1.8 V ≤ V _{DD} < 2.5 V; I _{OH} = −12 mA | V _{DD} − 0.4 | - | - | V |
| V _{OL} | LOW-level output voltage | 2.5 V ≤ V _{DD} ≤ 3.6 V; I _{OL} = 4 mA | - | - | 0.4 | V |
| | | 1.8 V ≤ V _{DD} < 2.5 V; I _{OL} = 3 mA | - | - | 0.4 | V |
| I _{OH} | HIGH-level output current | V _{OH} = V _{DD} − 0.4 V; 2.5 V ≤ V _{DD} ≤ 3.6 V | 20 | - | - | mA |
| | | 1.8 V ≤ V _{DD} < 2.5 V | 12 | - | - | mA |
| I _{OL} | LOW-level output current | V _{OL} = 0.4 V 2.5 V ≤ V _{DD} ≤ 3.6 V | 4 | - | - | mA |
| | | 1.8 V ≤ V _{DD} < 2.5 V | 3 | - | - | mA |
| I _{OLS} | LOW-level short-circuit output current | V _{OL} = V _{DD} ^[15] | - | - | 50 | mA |
| I _{pd} | pull-down current | V _I = 5 V | 10 | 50 | 150 | μA |
| I _{pu} | pull-up current | V _I = 0 V 2.0 V ≤ V _{DD} ≤ 3.6 V | −15 | −50 | −85 | μA |
| | | 1.8 V ≤ V _{DD} < 2.0 V | −10 | −50 | −85 | μA |
| | | V _{DD} < V _I < 5 V | 0 | 0 | 0 | μA |
| I ² C-bus pins (PIO0_4 and PIO0_5) | | | | | | |
| V _{IH} | HIGH-level input voltage | | 0.7V _{DD} | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.3V _{DD} | V |
| V _{hys} | hysteresis voltage | | - | 0.05V _{DD} | - | V |
| I _{OL} | LOW-level output current | V _{OL} = 0.4 V; I ² C-bus pins configured as standard mode pins 2.5 V ≤ V _{DD} ≤ 3.6 V | 3.5 | - | - | mA |
| | | 1.8 V ≤ V _{DD} < 2.5 V | 3 | - | - | |

10.3 ADC static characteristics

Table 18. ADC static characteristics

$T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$ unless otherwise specified; ADC frequency 4.5 MHz, $V_{DD} = 2.5\text{ V}$ to 3.6 V .

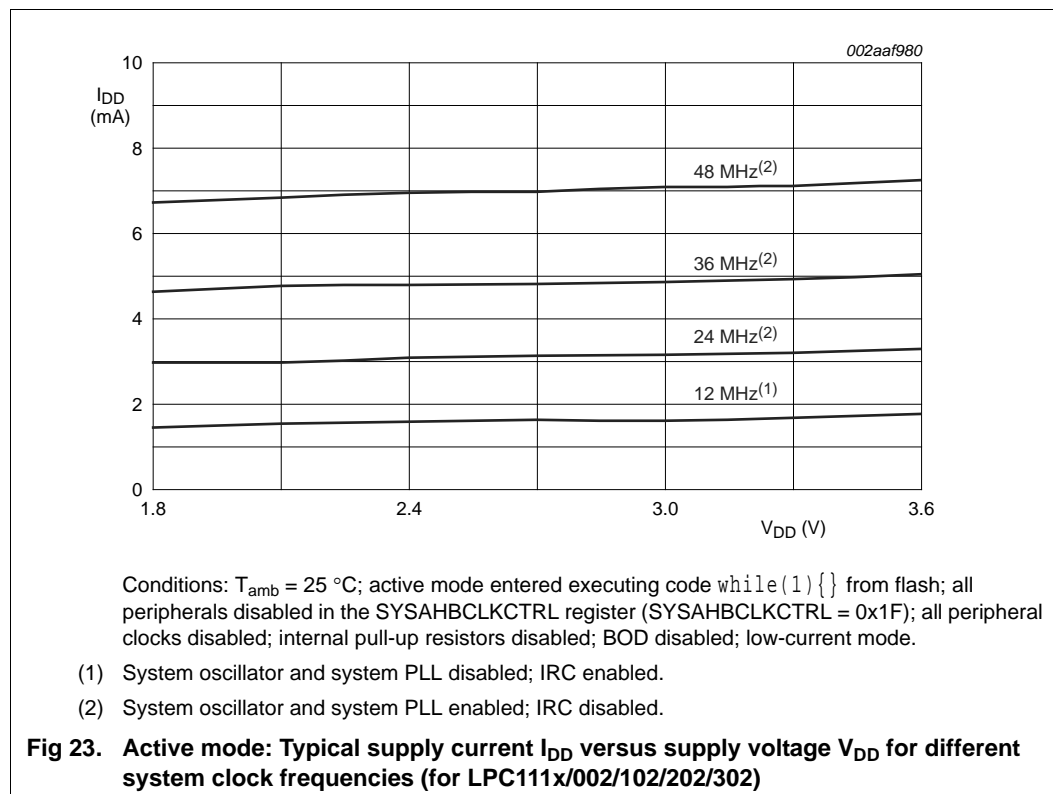
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------|-------------------------------------|------------|-----|-----|-----------|------------|
| V_{IA} | analog input voltage | | 0 | - | V_{DD} | V |
| C_{ia} | analog input capacitance | | - | - | 1 | pF |
| E_D | differential linearity error | [1][2] | - | - | ± 1 | LSB |
| $E_{L(adj)}$ | integral non-linearity | [3] | - | - | ± 1.5 | LSB |
| E_O | offset error | [4] | - | - | ± 3.5 | LSB |
| E_G | gain error | [5] | - | - | 0.6 | % |
| E_T | absolute error | [6] | - | - | ± 4 | LSB |
| R_{vsi} | voltage source interface resistance | | - | - | 40 | k Ω |
| R_i | input resistance | [7][8] | - | - | 2.5 | M Ω |

- [1] The ADC is monotonic, there are no missing codes.
- [2] The differential linearity error (E_D) is the difference between the actual step width and the ideal step width. See [Figure 17](#).
- [3] The integral non-linearity ($E_{L(adj)}$) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See [Figure 17](#).
- [4] The offset error (E_O) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the ideal curve. See [Figure 17](#).
- [5] The gain error (E_G) is the relative difference in percent between the straight line fitting the actual transfer curve after removing offset error, and the straight line which fits the ideal transfer curve. See [Figure 17](#).
- [6] The absolute error (E_T) is the maximum difference between the center of the steps of the actual transfer curve of the non-calibrated ADC and the ideal transfer curve. See [Figure 17](#).
- [7] $T_{amb} = 25\text{ }^{\circ}\text{C}$; maximum sampling frequency $f_s = 400\text{ kSamples/s}$ and analog input capacitance $C_{ia} = 1\text{ pF}$.
- [8] Input resistance R_i depends on the sampling frequency f_s : $R_i = 1 / (f_s \times C_{ia})$.

10.6 Power consumption LPC1100L series (LPC111x/002/102/202/302)

Power measurements in Active, Sleep, and Deep-sleep modes were performed under the following conditions (see *LPC111x user manual*):

- Configure all pins as GPIO with pull-up resistor disabled in the IOCONFIG block.
- Configure GPIO pins as outputs using the GPIO nDIR registers.
- Write 0 to all GPIO nDATA registers to drive the outputs LOW.



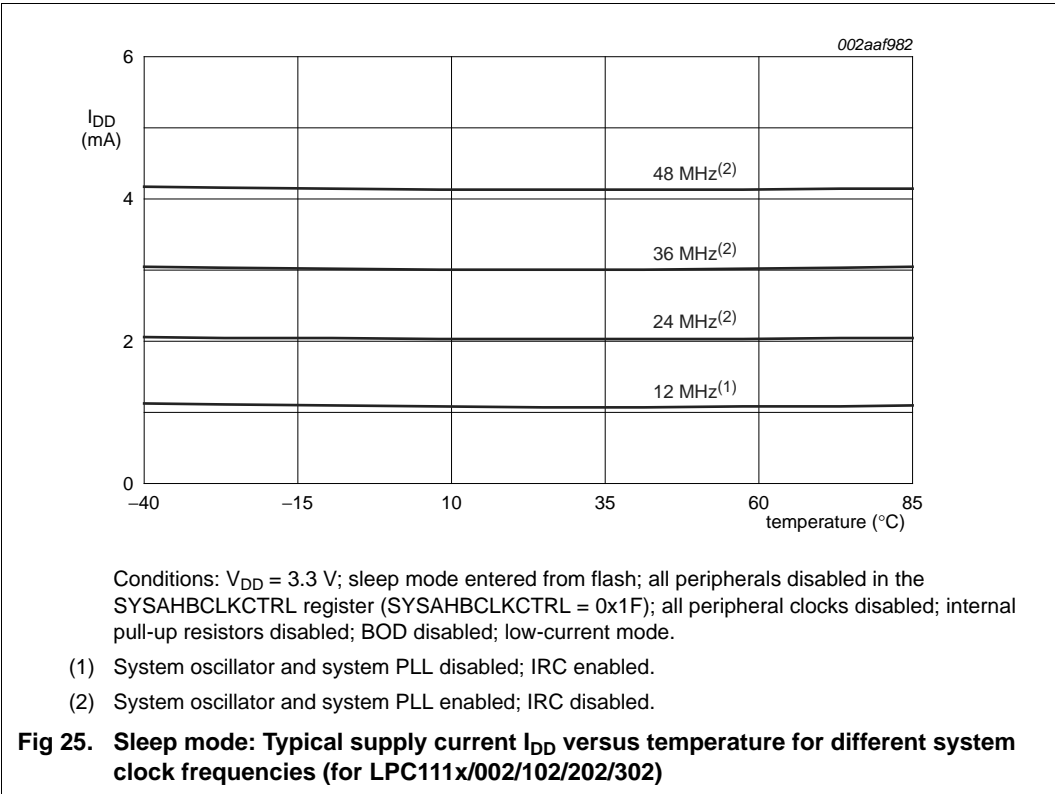
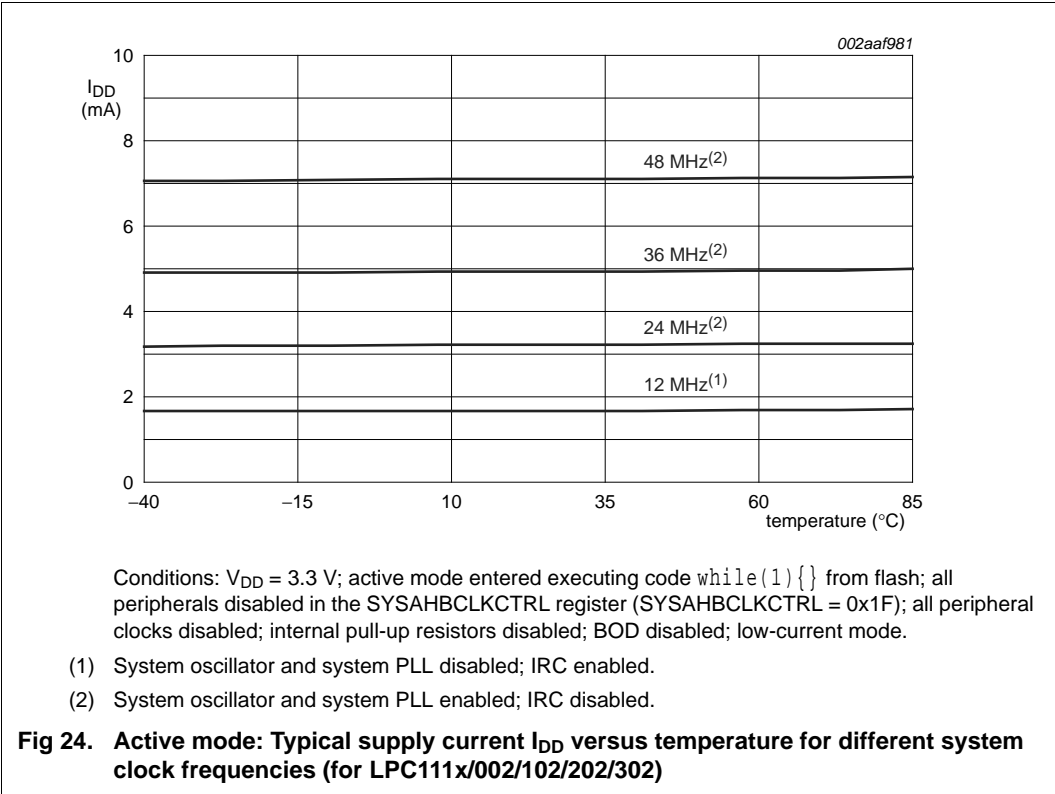


Table 26. Dynamic characteristics: Watchdog oscillator

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|-----------------------|-------------------------------|---|-----|--------------------|-----|------|
| $f_{\text{osc(int)}}$ | internal oscillator frequency | DIVSEL = 0x1F, FREQSEL = 0x1 ^{[2][3]} in the WDTOSCCTRL register; | - | 9.4 | - | kHz |
| | | DIVSEL = 0x00, FREQSEL = 0xF ^{[2][3]} in the WDTOSCCTRL register | - | 2300 | - | kHz |

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The typical frequency spread over processing and temperature ($T_{\text{amb}} = -40\text{ °C}$ to $+105\text{ °C}$) is $\pm 40\%$.

[3] See the LPC111x user manual.

11.5 I/O pins

Table 27. Dynamic characteristic: I/O pins^[1]

$T_{\text{amb}} = -40\text{ °C}$ to $+105\text{ °C}$; $3.0\text{ V} \leq V_{\text{DD}} \leq 3.6\text{ V}$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------|-----------|--------------------------|-----|-----|-----|------|
| t_r | rise time | pin configured as output | 3.0 | - | 5.0 | ns |
| t_f | fall time | pin configured as output | 2.5 | - | 5.0 | ns |

[1] Applies to standard port pins and $\overline{\text{RESET}}$ pin.

11.6 I²C-busTable 28. Dynamic characteristic: I²C-bus pins^[1] $T_{amb} = -40\text{ }^{\circ}\text{C to } +105\text{ }^{\circ}\text{C}$ ^[2]

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|--|-----------------------|-----|------|
| f _{SCL} | SCL clock frequency | Standard-mode | 0 | 100 | kHz |
| | | Fast-mode | 0 | 400 | kHz |
| | | Fast-mode Plus | 0 | 1 | MHz |
| t _f | fall time ^{[4][5][6][7]} | of both SDA and SCL signals Standard-mode | - | 300 | ns |
| | | Fast-mode | $20 + 0.1 \times C_b$ | 300 | ns |
| | | Fast-mode Plus | - | 120 | ns |
| t _{LOW} | LOW period of the SCL clock | Standard-mode | 4.7 | - | μs |
| | | Fast-mode | 1.3 | - | μs |
| | | Fast-mode Plus | 0.5 | - | μs |
| t _{HIGH} | HIGH period of the SCL clock | Standard-mode | 4.0 | - | μs |
| | | Fast-mode | 0.6 | - | μs |
| | | Fast-mode Plus | 0.26 | - | μs |
| t _{HD;DAT} | data hold time ^{[3][4][8]} | Standard-mode | 0 | - | μs |
| | | Fast-mode | 0 | - | μs |
| | | Fast-mode Plus | 0 | - | μs |
| t _{SU;DAT} | data set-up time ^{[9][10]} | Standard-mode | 250 | - | ns |
| | | Fast-mode | 100 | - | ns |
| | | Fast-mode Plus | 50 | - | ns |

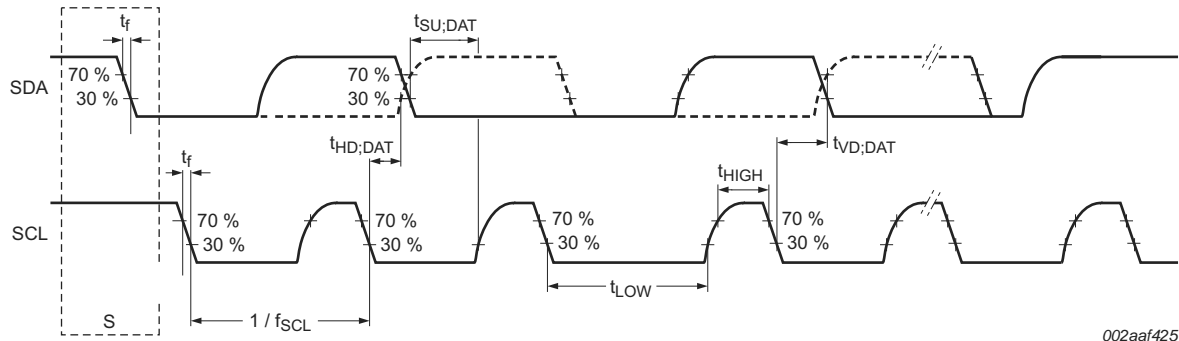
[1] See the I²C-bus specification *UM10204* for details.

[2] Parameters are valid over operating temperature range unless otherwise specified.

[3] t_{HD;DAT} is the data hold time that is measured from the falling edge of SCL; applies to data in transmission and the acknowledge.[4] A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V_{IH(min)} of the SCL signal) to bridge the undefined region of the falling edge of SCL.[5] C_b = total capacitance of one bus line in pF.[6] The maximum t_f for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time for the SDA output stage t_f is specified at 250 ns. This allows series protection resistors to be connected in between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t_f.

[7] In Fast-mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers should allow for this when considering bus timing.

[8] The maximum t_{HD;DAT} could be 3.45 μs and 0.9 μs for Standard-mode and Fast-mode but must be less than the maximum of t_{VD;DAT} or t_{VD;ACK} by a transition time (see *UM10204*). This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretches the SCL, the data must be valid by the set-up time before it releases the clock.[9] t_{SU;DAT} is the data set-up time that is measured with respect to the rising edge of SCL; applies to data in transmission and the acknowledge.[10] A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system but the requirement t_{SU;DAT} = 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t_{r(max)} + t_{SU;DAT} = 1000 + 250 = 1250 ns (according to the Standard-mode I²C-bus specification) before the SCL line is released. Also the acknowledge timing must meet this set-up time.

Fig 46. I²C-bus pins clock timing

11.7 SPI interfaces

Table 29. Dynamic characteristics of SPI pins in SPI mode

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------------------|------------------------|---|-----------------------------|-----|------------------------------|------|
| SPI master (in SPI mode) | | | | | | |
| $T_{cy(clk)}$ | clock cycle time | full-duplex mode [1] | 50 | - | - | ns |
| | | when only transmitting [1] | 40 | | | ns |
| t_{DS} | data set-up time | in SPI mode [2] $2.4\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | 15 | - | - | ns |
| | | $2.0\text{ V} \leq V_{DD} < 2.4\text{ V}$ [2] | 20 | | | ns |
| | | $1.8\text{ V} \leq V_{DD} < 2.0\text{ V}$ [2] | 24 | - | - | ns |
| t_{DH} | data hold time | in SPI mode [2] | 0 | - | - | ns |
| $t_{V(Q)}$ | data output valid time | in SPI mode [2] | - | - | 10 | ns |
| $t_{h(Q)}$ | data output hold time | in SPI mode [2] | 0 | - | - | ns |
| SPI slave (in SPI mode) | | | | | | |
| $T_{cy(PCLK)}$ | PCLK cycle time | | 20 | - | - | ns |
| t_{DS} | data set-up time | in SPI mode [3][4] | 0 | - | - | ns |
| t_{DH} | data hold time | in SPI mode [3][4] | $3 \times T_{cy(PCLK)} + 4$ | - | - | ns |
| $t_{V(Q)}$ | data output valid time | in SPI mode [3][4] | - | - | $3 \times T_{cy(PCLK)} + 11$ | ns |
| $t_{h(Q)}$ | data output hold time | in SPI mode [3][4] | - | - | $2 \times T_{cy(PCLK)} + 5$ | ns |

[1] $T_{cy(clk)} = (SSPCLKDIV \times (1 + SCR) \times CPSPVSR) / f_{main}$. The clock cycle time derived from the SPI bit rate $T_{cy(clk)}$ is a function of the main clock frequency f_{main} , the SPI peripheral clock divider (SSPCLKDIV), the SPI SCR parameter (specified in the SSP0CR0 register), and the SPI CPSPVSR parameter (specified in the SPI clock prescale register).

[2] $T_{amb} = -40\text{ °C}$ to 105 °C .

[3] $T_{cy(clk)} = 12 \times T_{cy(PCLK)}$.

[4] $T_{amb} = 25\text{ °C}$; for normal voltage supply range: $V_{DD} = 3.3\text{ V}$.

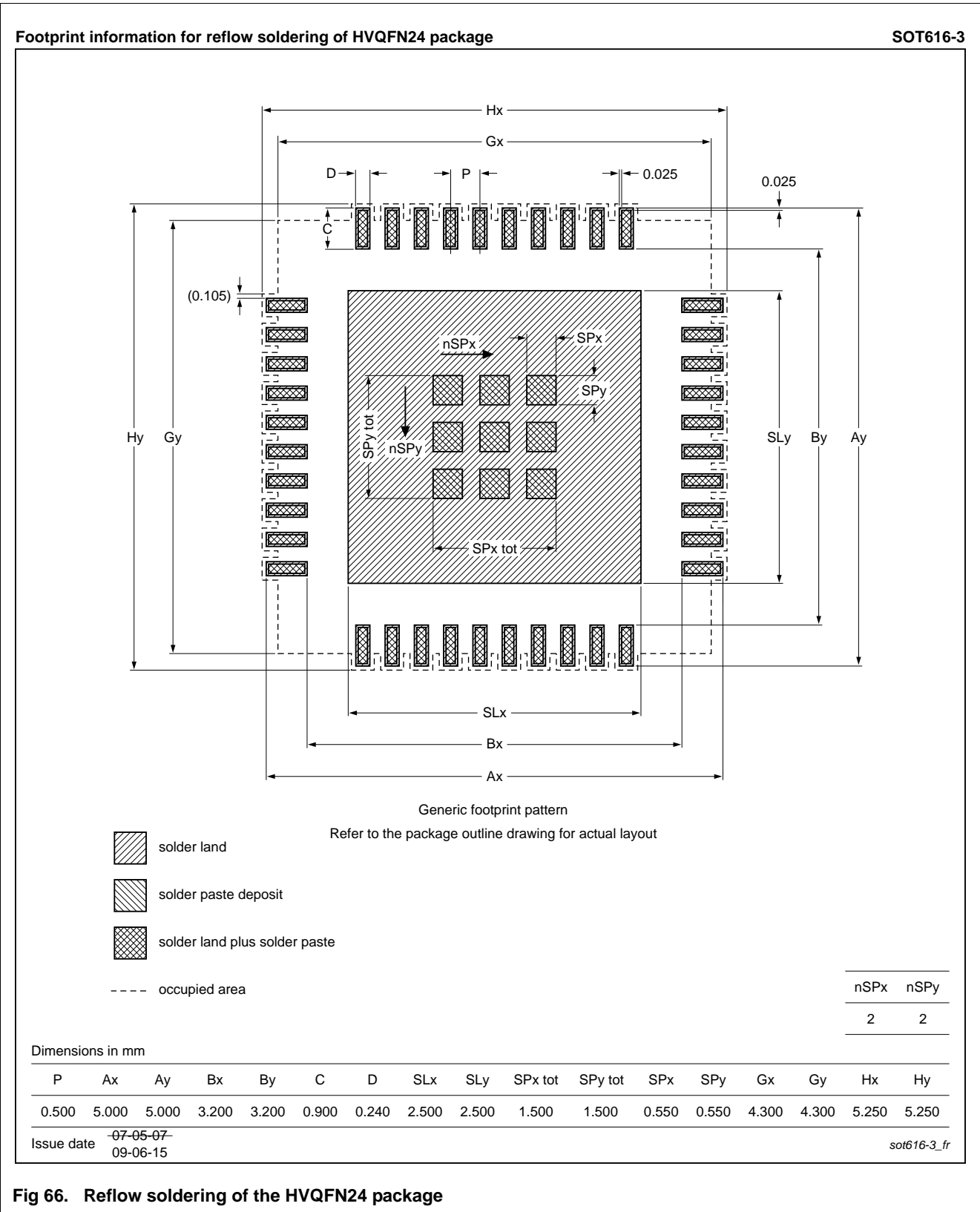


Fig 66. Reflow soldering of the HVQFN24 package

15. Abbreviations

Table 33. Abbreviations

| Acronym | Description |
|---------|---|
| ADC | Analog-to-Digital Converter |
| AHB | Advanced High-performance Bus |
| APB | Advanced Peripheral Bus |
| BOD | BrownOut Detection |
| GPIO | General Purpose Input/Output |
| PLL | Phase-Locked Loop |
| RC | Resistor-Capacitor |
| SPI | Serial Peripheral Interface |
| SSI | Serial Synchronous Interface |
| SSP | Synchronous Serial Port |
| TEM | Transverse ElectroMagnetic |
| UART | Universal Asynchronous Receiver/Transmitter |

16. References

- [1] LPC111x/LPC11Cxx User manual UM10398:
http://www.nxp.com/documents/user_manual/UM10398.pdf
- [2] LPC111x Errata sheet:
http://www.nxp.com/documents/errata_sheet/ES_LPC111X.pdf

17. Revision history

Table 34. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---|--------------------|---------------|---------------|
| LPC111X v.9.2 | 20140326 | Product data sheet | - | LPC111X v.9.1 |
| Modifications: | <ul style="list-style-type: none"> Pin description tables for RESET/PIO0_0 updated: In deep power-down mode, this pin must be pulled HIGH externally. The RESET pin can be left unconnected or be used as a GPIO pin if an external RESET function is not needed. See Section 6.2. Pin description notes relating to open-drain I2C-bus pins updated for clarity in Section 6.2. Pin description of the WAKEUP pin updated for clarity. See Section 6.2. Parts added: LPC1114JHI33/303, LPC1111JHN33/103, LPC1112JHN33/203, LPC1113JHN33/203, LPC1114JHN33/303, LPC1114JBD48/333, LPC1112FHI33/102, LPC1114JBD48/303, LPC1114JBD48/323, LPC1113JBD48/303, LPC1113JHN33/303, LPC1112JHN33/103, LPC1111JHN33/203, LPC1114JHN33/203. | | | |
| LPC111X v.9.1 | 20131213 | Product data sheet | - | LPC111X v.9 |
| Modifications: | <ul style="list-style-type: none"> Table 17 "Static characteristics (LPC1100XL series)": <ul style="list-style-type: none"> Added I_{DD} max spec for Deep-sleep and Deep power-down modes @ 25 °C and 105 °C. Added Table note 11 "105 °C spec applies only to the LPC1112JHI33, LPC1114JHN33, LPC1115JBD48, and LPC1115JET48 parts." Updated Table note 12 "WAKEUP pin and RESET pin are pulled HIGH externally." Table 16 "Static characteristics (LPC1100, LPC1100L series)": <ul style="list-style-type: none"> Updated Table note 9 "WAKEUP pin and RESET pin are pulled HIGH externally." | | | |
| LPC111X v.9 | 20131029 | Product data sheet | - | LPC111X v.8.2 |
| Modifications: | <ul style="list-style-type: none"> Added LPC1112JHI33/203, LPC1114JHN33/333, LPC1115JBD48/303, and LPC1115JET48/303 parts. Removed t_{clk(H)} and t_{clk(L)} from Figure 47 "SPI master timing in SPI mode" and Figure 48 "SPI slave timing in SPI mode"; spec not characterized. Table 22 "Power-up characteristics[1]": Added table note "Does not apply to LPC1100XL series". | | | |
| LPC111X v.8.2 | 20130805 | Product data sheet | - | LPC111X v.8.1 |
| Modifications: | <ul style="list-style-type: none"> Added LPC1115FET48/303. | | | |
| LPC111X v.8.1 | 20130524 | Product data sheet | - | LPC111X v.8 |
| Modifications: | <ul style="list-style-type: none"> Table 4 thru Table 11: Added "5 V tolerant pad" to RESET/PIO0_0 table note. Added Section 9 "Thermal characteristics". SRAM size corrected for part LPC1112FHN24/202 (4 kB). See Table 2. | | | |
| LPC111X v.8 | 20130220 | Product data sheet | - | LPC111X v.7.5 |
| Modifications: | <ul style="list-style-type: none"> Table 16 "Static characteristics" added Pin capacitance section. Default pin state corrected for pins PIO0_4 and PIO0_5 (I; IA) in Table 11 "LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package)". Table 12 "Limiting values" expanded for clarity. Table 19 "Power consumption at very low frequencies using the watchdog oscillator" added. Added Section 12.2 "Use of ADC input trigger signals". Added Section 12.8 "ADC effective input impedance". | | | |
| LPC111X v.7.5 | 20121002 | Product data sheet | - | LPC111X v.7.4 |

Table 34. Revision history ...continued

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------------------|--|--------------------|---------------|-------------------------|
| Modifications: | BOD level 0 for reset added in Table 15. | | | |
| LPC111X v.7.4 | 20120730 | Product data sheet | - | LPC111X v.7.3 |
| Modifications: | <ul style="list-style-type: none"> Function SSEL1 added to pin PIO2_0 in Figure 6 "LPC1100XL series pin configuration HVQFN33" and Table 11 "LPC1100XL series: LPC1111/12/13/14 pin description table (HVQFN33 package)". BOD level 0 for reset and interrupt removed. | | | |
| LPC111X v.7.3 | 20120706 | Product data sheet | - | LPC111X v.7.2 |
| Modifications: | <ul style="list-style-type: none"> Corrected pinout for part LPC1112FHN24/202. Pin XTALOUT replaced by V_{DD}. See Table 6 and Figure 10. | | | |
| LPC111X v.7.2 | 20120604 | Product data sheet | - | LPC111X v.7.1 |
| Modifications: | <ul style="list-style-type: none"> For parameters I_{OL}, V_{OL}, I_{OH}, V_{OH}, changed conditions to 1.8 V ≤ V_{DD} < 2.5 V and 2.5 V ≤ V_{DD} ≤ 3.6 V in Table 13). Capture-clear feature added to general-purpose counter/timers (see Section 7.12; LPC1100XL series only). Figure 47 updated for parts with configurable open-drain mode. Added Section 9.5 "CoreMark data" Added LPC1100L series part (LPC1112FHN24/202). WDOSc frequency range corrected. | | | |
| LPC111X v.7.1 | 20120401 | Product data sheet | - | LPC111X v.7 |
| Modifications: | <ul style="list-style-type: none"> Added HVQFN33 (5x5) reflow soldering information. | | | |
| LPC111X v.7 | 20120301 | Product data sheet | - | LPC1110_11_12_13_14 v.6 |
| Modifications: | <ul style="list-style-type: none"> LPC1100XL series parts added (LPC1111FHN33/103, LPC1111FHN33/203, LPC1112FHN33/103, LPC1112FHN33/203, LPC1112FHI33/203, LPC1113FBD48/303, LPC1113FHN33/203, LPC1113FHN33/303, LPC1114FBD48/303, LPC1114FHN33/203, LPC1114FHN33/303, LPC1114FHI33/303, LPC1114FBD48/323, LPC1114FBD48/333, LPC1114FHN33/333, LPC1115FBD48/303). | | | |
| LPC1110_11_12_13_14 v.6 | 20111102 | Product data sheet | - | LPC1111_12_13_14 v.5 |
| Modifications: | <ul style="list-style-type: none"> Parts LPC1112FHI33/202 and LPC1114FHI33/302 added. Parts LPC1112FDH28/102, LPC1114FDH28/102, LPC1114FN28/102, LPC1112FDH20/102, LPC1110FD20, LPC1111FDH20/002, LPC1112FD20/102 added. | | | |
| LPC1111_12_13_14 v.5 | 20110622 | Product data sheet | - | LPC1111_12_13_14 v.4 |
| Modifications: | <ul style="list-style-type: none"> ADC sampling frequency corrected in Table 7 (Table note 7). Pull-up level specified in Table 3 to Table 4 and Section 7.7.1. Parameter T_{cy(clk)} corrected on Table 17. WWDT for parts LPC111x/102/202/302 added in Section 2 and Section 7.15. Programmable open-drain mode for parts LPC111x/102/202/302 added in Section 2 and Section 7.12. Condition for parameter T_{stg} in Table 5 updated. Table note 4 of Table 5 updated. Section 13 added. Removed PLCC44 package information. | | | |
| LPC1111_12_13_14 v.4 | 20110210 | Product data sheet | - | LPC1111_12_13_14 v.3 |